



Docket: 5853-316CIP  
UF No.: 10324

### DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

#### **THERMAL MANAGEMENT DEVICE**

the specification of which (check one)

     is attached hereto.  
X was filed on July 29, 2003 as Application Serial No. 10/629,487 and  
was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	Yes No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	Yes No

I hereby claim the benefit under Title 35, United States Code, §119(e) of any U.S. application listed below and identified as a provisional application, insofar as the subject matter of each of the claims of this application is not disclosed in the prior U.S. application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information material to the patentability of this application as defined in Title 37,

Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

### Prior U.S. Provisional Application(s)

[illegible]

60/209,335

June 2, 2000

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

09/874,656  
(Appln. Serial No.)

June 4, 2001  
(Filing Date)

U.S. Patent No. 6,598,409  
(Status-patent, pending, abandoned)

(Appln. Serial No.)

(Filing Date)

(Status-patent, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint all registered patent practitioners associated with Customer Number 30448 to prosecute this application and transact all business in the U.S. Patent and Trademark Office connected therewith:

Send correspondence to Neil R. Jetter, Esq., Akerman, Senterfitt, 222 Lakeview Avenue, 4<sup>th</sup> Floor, P.O. Box 3188, West Palm Beach, Florida 33402-3188 and direct all telephone calls to Neil R. Jetter, Esq. at (561) 653-5000.

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INVENTOR'S SIGNATURE: Wei Shyy

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FULL NAME OF 2<sup>nd</sup> INVENTOR: MARIANNE MONIQUE FRANCOIS

INVENTOR'S SIGNATURE: \_\_\_\_\_

DATE: \_\_\_\_\_

RESIDENCE: 288 Corry Village #3, Gainesville, Florida 32603

CITIZENSHIP: France

FULL NAME OF 3<sup>rd</sup> INVENTOR: JACOB NAN-CHU CHUNG

INVENTOR'S SIGNATURE: \_\_\_\_\_

DATE: \_\_\_\_\_

RESIDENCE: 9431 SW 38<sup>th</sup> Lane, Gainesville, Florida 32608

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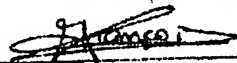
FULL NAME OF 1<sup>st</sup> INVENTOR: WEI SHYY

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